Ceramic Resonator MHz SMD Type Two-Three Terminal Series (7.00MHz to 50.00MHz)

ITEM	CONDITION & REQUIREMENT		
5-1.	After being placed in a chamber with $+85 \pm 2$ °C for 500 hours and then being		
Storage in High Temp.	placed in natural condition for 2 hour, then measure.		
8 1	\Rightarrow To be satisfied Table 1.		
5-2.	After being placed in a chamber with -55 \pm 2 °C for 500 hours and then being		
Storage in Low Temp.	placed in natural condition for 2 hour, then measure.		
	\Rightarrow To be satisfied Table 1.		
5-3.	After being placed in a chamber within +90 to 95% R. H. at +60 \pm 2 °C for		
Humidity	500 hours and then being placed in natural condition for 2 hour, then measure.		
	\Rightarrow To be satisfied Table 1.		
5-4.	After being kept at room temperature, the resonator shall be placed at temperature of		
Heat Shock	-55 °C. After 30 minutes at this temperature resonator shall be immediately placed at		
	temperature of +85 °C. After 30 minutes at this temperature		
	resonator shall be returned to -55 °C again. After five above cycles, the resonator		
	shall be returned to room temperature for at least 2 hour, then measure.		
	\Rightarrow To be satisfied Table 1.		
5-5.	Resonator shall be measured after 3 times random drops from the height of		
Random Drop	1 m on wooden floor.		
	\Rightarrow No visible damage and the measured values shall meet Table 1.		
5-6.	Resonator shall be measured after being applied vibration of amplitude to 1.5mm with		
Vibration Test	st 10 to 55Hz band of vibration frequency to each of a perpendicular dir- ections		
	hours.		
	\Rightarrow No visible damage and the measured values shall meet Table 1.		
5-7.	Resonator is soldered onto the center of PCB which is laid on the 2 small supporters		
Bending Strength PCB	spaced 90mm. PCB deflected to 1mm below from horizontal level by the pressing		
	force with 20x10.R10 stick. The force is supplied for 1 second, 5 times repeatedly.		
	Velocity of pole for press: 0.5mm/sec.		
	<u>.</u>		
	20x10.R10 Stick		
	1.0		
	Deflection		
	45 45		
	Unit : mm		
	\Rightarrow No visible damage and the measured values shall meet Table 1.		



ITEM	CONDITION & REQUIREMENT	
5-8.	End terminals are immersed in rosin for 5 seconds and then immersed in soldering	
Solderability	bath of 245±5°C for 3±0.5 seconds.	
	\Rightarrow 75% min. End terminals shall be wet with solder.	
5-9. Resistance to Soldering Heat		
(1) Reflow	Following profile of heat stress is applied to resonator, then being place in natural condition for 1 hour, resonator shall be measured.	
	Temperatrure($^{\circ}$ C)	
	Preheating (in air) 170 Preheating (in air) 10sec. max. 1 Preheating conditions shall be 150 to 170 °C for 120 to 160 seconds. Ascending time up to 170 °C shall be longer than 30 seconds. 2. Heating conditions shall be within 10 seconds at 245 °C min., but peak	
	temperature shall be lower than 260°C.	
(2) Soldering Iron	Soldering iron of 300±5°C shall be placed 0.5mm above from electrode of resonator. Melting solder through soldering iron shall be applied to electrode for 3±1 seconds, then being place in natural condition for 24 hour, resonator shall be measured.	
	⇒ The measured values shall meet Table 1.	

TABLE 1

MEASUREMENTS	REQUIREMENTS
7~12MHz Oscillating Frequency	± 0.3 % max.(from initial value)
16~50MHz Oscillating Frequency	± 0.2 % max.(from initial value)

